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Fairchild Semiconductor MOC119M

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January 2009

# MOC119M Photodarlington Optocoupler (No Base Connection)

#### **Features**

- High current transfer ratio of 300%
- No base connection for improved noise immunity
- Underwriters Laboratory (UL) recognized File #E90700
- IEC 60747-5-2 approval available as a test option add option 'V' (e.g., MOC119VM)

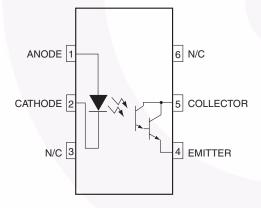
## **Applications**

- Appliances, measuring instruments
- I/O interface for computers
- Programmable controllers
- Portable electronics
- Interfacing and coupling systems of different potentials and impedance
- Solid state relays

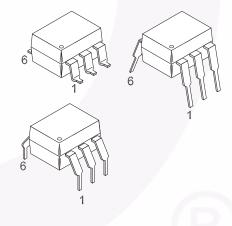
## **Description**

The MOC119M device has a gallium arsenide infrared emitting diode coupled to a silicon darlington phototransistor.

#### **Schematic**



## **Package Outlines**





## **Absolute Maximum Ratings** (T<sub>A</sub> = 25°C unless otherwise specified.)

Stresses exceeding the absolute maximum ratings may damage the device. The device may not function or be operable above the recommended operating conditions and stressing the parts to these levels is not recommended. In addition, extended exposure to stresses above the recommended operating conditions may affect device reliability. The absolute maximum ratings are stress ratings only.

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Symbol	Parameter	Value	Units
TOTAL DEVICE		-	
T <sub>STG</sub>	Storage Temperature	-40 to +150	°C
T <sub>OPR</sub>	Operating Temperature	-40 to +100	°C
T <sub>SOL</sub>	Lead Solder Temperature (wave solder)	260 for 10 sec	°C
P <sub>D</sub>	Total Device Power Dissipation @ T <sub>A</sub> = 25°C	250	mW
	Derate above 25°C	2.94	mW/°C
EMITTER			
I <sub>F</sub>	DC/Average Forward Input Current	60	mA
V <sub>R</sub>	Reverse Input Voltage	3	V
P <sub>D</sub>	LED Power Dissipation @ T <sub>A</sub> = 25°C	120	mW
	Derate above 25°C	1.41	mW/°C
DETECTOR			
V <sub>CEO</sub>	Collector-Emitter Voltage	30	V
V <sub>ECO</sub>	Emitter-Collector Voltage	7	V
P <sub>D</sub>	Detector Power Dissipation @ T <sub>A</sub> = 25°C	150	mW
	Derate above 25°C	1.76	mW/°C
I <sub>C</sub>	Continuous Collector Current	150	mA



## Electrical Characteristics (T<sub>A</sub> = 25°C unless otherwise specified.)

## **Individual Component Characteristics**

Symbol	Parameter	Parameter Test Conditions Min.		Typ.*	Max.	Unit
EMITTER						
V <sub>F</sub>	Input Forward Voltage	I <sub>F</sub> = 10mA		1.15	1.5	V
C <sub>IN</sub>	Input Capacitance	V <sub>R</sub> = 0, f = 1MHz		18		pF
I <sub>R</sub>	Reverse Leakage Current	V <sub>R</sub> = 3.0V		0.05	100	μA
DETECTOR						
BV <sub>CEO</sub>	Collector-Emitter Breakdown Voltage	I <sub>C</sub> = 100μA	30			V
BV <sub>ECO</sub>	Emitter-Collector Breakdown Voltage	I <sub>E</sub> = 10μA	7			V
I <sub>CEO</sub>	Collector-Emitter Dark Current	V <sub>CE</sub> = 10V			100	nA

### **Transfer Characteristics**

Symbol	Parameter	Test Conditions	Min.	Typ.*	Max.	Units
DETECTOR						
CTR	Current Transfer Ratio	I <sub>F</sub> = 10mA, V <sub>CE</sub> = 2V	300	450		%
V <sub>CE (SAT)</sub>	Collector-Emitter Saturation Voltage	I <sub>C</sub> = 10mA, I <sub>F</sub> = 10mA			1	V
SWITCHING	TIMES					
t <sub>on</sub>	Turn-on Time	$V_{CE} = 10V, R_{L} = 100\Omega,$		3.5		μs
t <sub>off</sub>	Turn-off Time	I <sub>F</sub> = 5mA		95		μs

### **Isolation Characteristics**

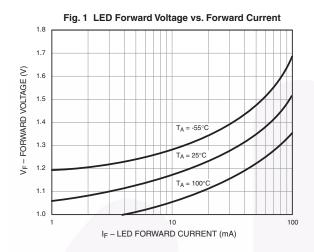
Symbol	Characteristic	Test Conditions	Min.	Тур.*	Max.	Units
V <sub>ISO</sub>	Input-Output Isolation Voltage	f = 60Hz, t = 1 sec.	7500			Vac(pk)
R <sub>ISO</sub>	Isolation Resistance	V <sub>I-O</sub> = 500VDC		10 <sup>11</sup>		Ω
C <sub>ISO</sub>	Isolation Capacitance	V = 0V, f = 1MHz		0.2		pF

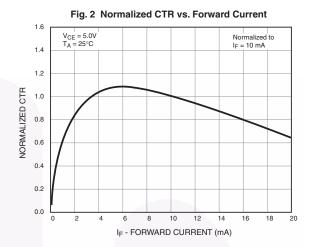
<sup>\*</sup>Typical values at T<sub>A</sub> = 25°C

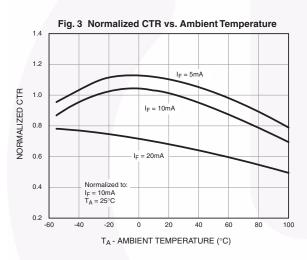
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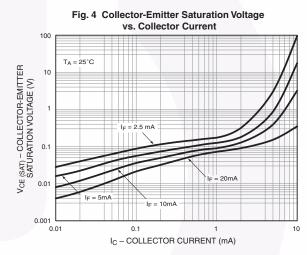




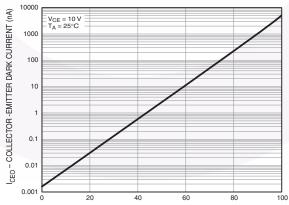










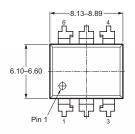


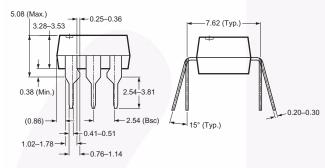
T<sub>A</sub> – AMBIENT TEMPERATURE (°C)



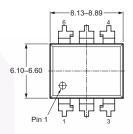
## **Package Dimensions**

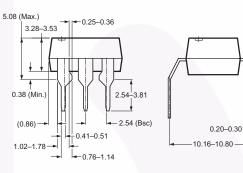
### **Through Hole**



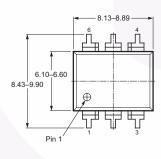


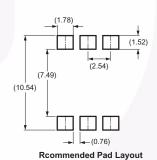
### 0.4" Lead Spacing

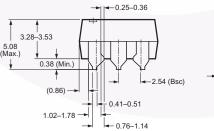


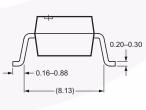


#### **Surface Mount**









#### Note:

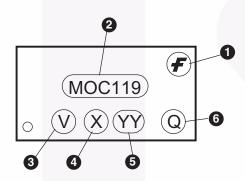
All dimensions in mm.



## **Ordering Information**

Suffix	Example	Option	
No Suffix	MOC119M	Standard Through Hole Device (50 units per tube)	
S	MOC119SM	Surface Mount Lead Bend	
SR2	MOC119SR2M	Surface Mount; Tape and Reel (1,000 units per reel)	
Т	MOC119TM	0.4" Lead Spacing	
V	MOC119VM	IEC60747-5-2 approved	
TV	MOC119TVM	IEC60747-5-2 approved, 0.4" Lead Spacing	
SV	MOC119SVM	IEC60747-5-2 approved, Surface Mount	
SR2V	MOC119SR2VM	IEC60747-5-2 approved, Surface Mount, Tape & Reel (1,000 units per reel)	

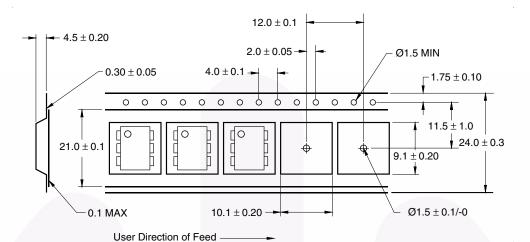
## **Marking Information**



Definitions				
1	1 Fairchild logo			
2	Device number			
3	VDE mark (Note: Only appears on parts ordered with VDE option – See order entry table)			
4	One digit year code, e.g., '7'			
5	Two digit work week ranging from '01' to '53'			
6	Assembly package code			



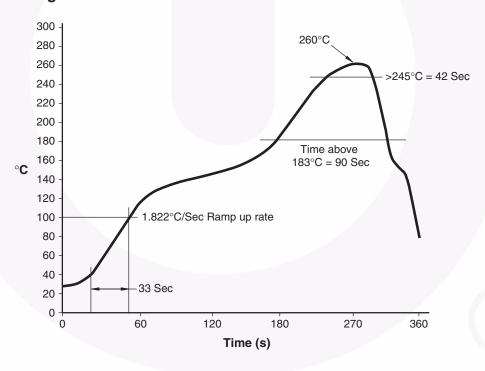
## **Tape Dimensions**



#### Note:

All dimensions are in millimeters.

## **Reflow Soldering Profile**





## Distributor of Fairchild Semiconductor: Excellent Integrated System Limited Datasheet of MOC119M - OPTOISO 5.3KV DARLINGTON 6-DIP

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#### Definition of Terms

Definition of Terms				
Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
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Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

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